

1.7 V to 5.5 V, 3 A Load Switch with Negative V_{IN} Tolerance

DESCRIPTION

The SiP32448 and SiP32449 are low resistance slew rate controlled load switches. The part operates from 1.7 V to 5.5 V supply and can tolerate negative voltage at input to -2 V. The integrated charge pump drivers enable the part with low on resistance over the wide input voltage range.

Both SiP32448 and SiP32449 feature a controlled soft-on slew rate of typical 2.5 ms that limits the inrush current for designs of heavy capacitive load and minimizes the resulting voltage droop at the power rails.

The SiP32448 and SiP32449 feature a constant low voltage control logic interface over the full operation voltage range. It can interface with low voltage control signals without extra level shifting circuit. When EN is left open, the part will not turn on until V_{IN} is greater than 2.5 V.

The SiP32449 has an output discharge to help discharge the output capacitor during shutdown mode for fast turn off.

The SiP32448 and SiP32449 have exceptionally low shutdown current and provides reverse blocking to prevent high current flowing into the power source when the switch is off or V_{IN} is ground.

Both SiP32448 and SiP32449 are available in TDFN4 package of 1.2 mm x 1.6 mm x 0.55 mm.

FEATURES

- 1.7 V to 5.5 V input voltage range
- Negative input voltage tolerance down to -2 V
- 38 m Ω typical R_{ON} from 1.8 V to 5 V
- 3 A maximum continuous switch current
- Slew rate controlled turn-on: 2.5 ms at 3.6 V
- Constant low control logic: $V_{IH} = 1.15$ V, $V_{IL} = 0.7$ V
- 2 V UVLO when EN is open
- Reverse current blocking when switch is off or V_{IN} is ground
- Output discharge (SiP32449)
- ESD protected
 - HBM: >6 kV
 - MM: >300 V
 - IEC61000-4-2 air discharge: >15 kV
 - IEC61000-4-2 contact discharge: >8 kV
- Compact TDFN4 package
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- PDAs / smart phones
- Notebook / netbook computers
- Tablet PC
- Portable media players
- Digital camera
- GPS navigation devices
- Data storage devices
- Optical, industrial, medical, and healthcare devices

TYPICAL APPLICATION CIRCUIT

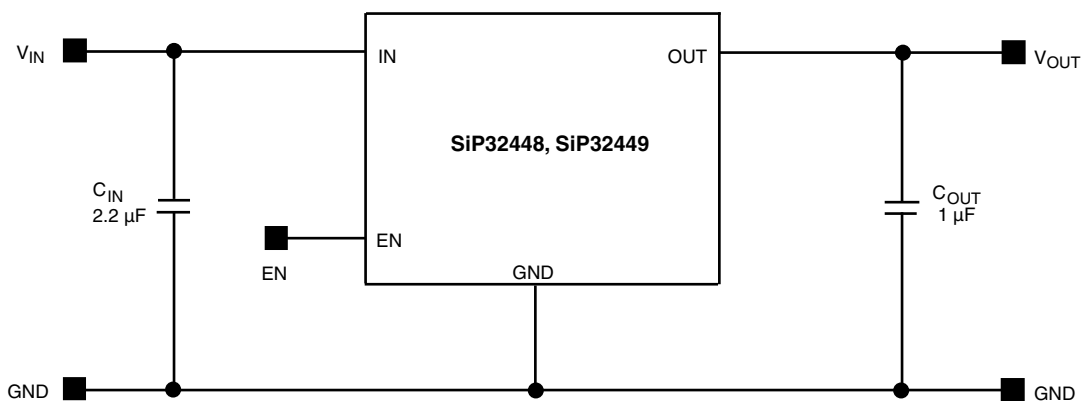


Fig. 1 - SiP32448, SiP32449 Typical Application Circuit



ORDERING INFORMATION				
Part Number	Package	Marking	Output Discharge	Temperature Range
SiP32448DNP-T1-GE4	TDFN4 1.2 mm x 1.6 mm	Lx	No	-40 °C to +85 °C
SiP32449DNP-T1-GE4		Px	Yes	

Notes

- x = Lot code
- GE4 denotes halogen-free and RoHS compliant

ABSOLUTE MAXIMUM RATINGS			
Parameter	Limit	Unit	
Supply Input Voltage (V _{IN})	-2 to +6	V	
Enable Input Voltage (V _{EN})	-2 to +6		
Output Voltage (V _{OUT})	-0.3 to +6		
Maximum Continuous Switch Current (I _{max.}) ^c	4	A	
Maximum Repetitive Pulsed Current (1 ms, 10 % Duty Cycle) ^c	7		
Maximum Non-Repetitive Pulsed Current (100 μs, EN = Active) ^c	12		
Junction Temperature (T _J)	-40 to +150	°C	
Thermal Resistance (q _{JA}) ^a	170	°C/W	
Power Dissipation (P _D) ^{a,b}	735	mW	
ESD Rating	HBM	6	kV
	MM	300	V
	IEC41000-4-2 Air Discharge ^d	15	kV
	IEC41000-4-2 Contact Discharge ^d	8	

Notes

- Device mounted with all leads and power pad soldered or welded to PC board, see PCB layout.
- Derate 5.9 mW/°C above T_A = 25 °C, see PCB layout.
- T_A = 25 °C, see PCB layout.
- Tested on V_{IN} with 2.2 μF C_{IN}. V_{IN} connected to micro-USB connector.

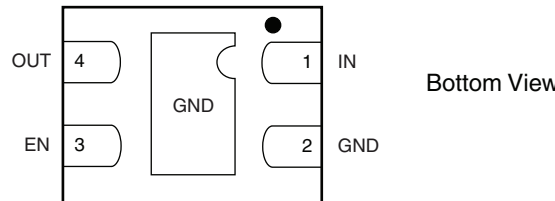
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE		
Parameter	Limit	Unit
Input Voltage Range (V _{IN})	1.7 to 5.5	V
Operating Junction Temperature Range (T _J)	-40 to +125	°C

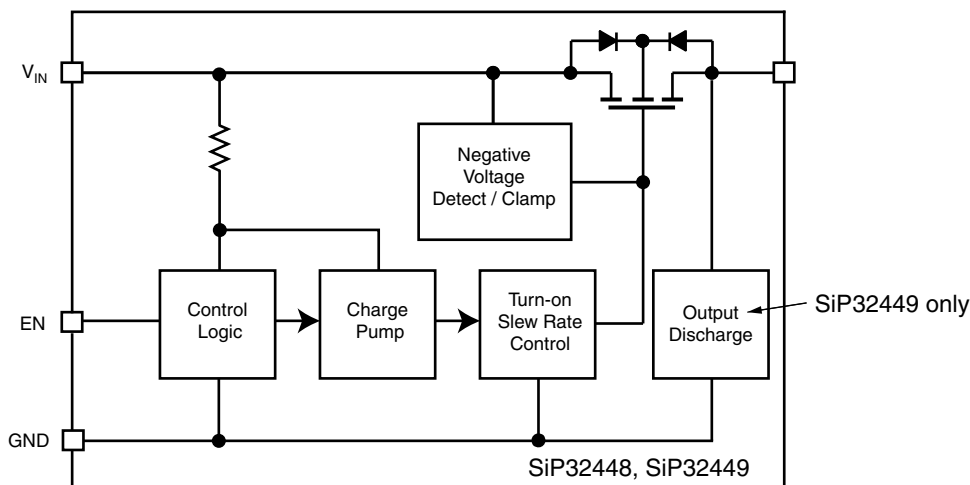
SPECIFICATIONS						
Parameter	Symbol	Test Conditions Unless Specified $V_{IN} = 5\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$ (Typical values are at $T_A = 25\text{ }^\circ\text{C}$)	Limits -40 °C to +85 °C			Unit
			Min. ^a	Typ. ^b	Max. ^a	
Operating Voltage ^c	V_{IN}		1.7	-	5.5	V
Negative Input Voltage Tolerance	I_{NEG}	$V_{IN} = -2\text{ V}$	-	-15	-	mA
Under Voltage Lock Out	UVLO _{H-L}	EN = open, 25 °C (switch On to Off)	-	-	2	V
	UVLO _{L-H}	EN = open, 25 °C (switch Off to On)	2.5	-	-	
UVLO Hysteresis	UVLO _{HYS}	EN = open, 25 °C	-	0.25	-	
Quiescent Current	I_Q	$V_{IN} = 1.8\text{ V}$, EN = active	-	35	50	μA
		$V_{IN} = 2.5\text{ V}$, EN = active	-	54	90	
		$V_{IN} = 3.6\text{ V}$, EN = active	-	78	110	
		$V_{IN} = 4.3\text{ V}$, EN = active	-	93	130	
		$V_{IN} = 5\text{ V}$, EN = active	-	110	180	
Off Supply Current	$I_{Q(off)}$	EN = inactive, OUT = open	-	8	18	
Off Switch Current	$I_{DS(off)}$	EN = inactive, OUT = GND	-	-	1	
Reverse Blocking Current	I_{RB}	$V_{OUT} = 5\text{ V}$, $V_{IN} = 0\text{ V}$, $V_{EN} = \text{inactive}$	-	-	10	
On-Resistance	$R_{DS(on)}$	$V_{IN} = 1.8\text{ V}$, $I_L = 500\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$	-	38	43	m Ω
		$V_{IN} = 2.5\text{ V}$, $I_L = 500\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$	-	38	43	
		$V_{IN} = 3.6\text{ V}$, $I_L = 500\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$	-	38	43	
		$V_{IN} = 4.3\text{ V}$, $I_L = 500\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$	-	38	43	
		$V_{IN} = 5\text{ V}$, $I_L = 500\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$	-	38	43	
On-Resistance Temp.-Coefficient	TC_{RDS}		-	3100	-	ppm/°C
EN Input Low Voltage ^c	V_{IL}	$V_{IN} = 1.8\text{ V}$ to 5.5 V	-	-	0.7 ^d	V
EN Input High Voltage ^c	V_{IH}		1.15 ^d	-	-	
EN Input Leakage	I_{SINK}	$V_{EN} = 5.5\text{ V}$	-6	-	6	μA
Output Pulldown Resistance	R_{PD}	EN = inactive, $T_A = 25\text{ }^\circ\text{C}$ (for SiP32449 only)	-	210	280	Ω
Output Turn-On Delay Time	$t_{d(on)}$	$V_{IN} = 3.6\text{ V}$, $R_{load} = 10\text{ }\Omega$, $T_A = 25\text{ }^\circ\text{C}$	-	1.35	-	ms
Output Turn-On Rise Time	$t_{(on)}$		1	1.7	3.8	
Output Turn-Off Delay Time	$t_{d(off)}$		-	-	0.005	

Notes

- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- For V_{IN} outside this range consult typical EN threshold curve.
- Not tested, guarantee by design.

PIN CONFIGURATION

Fig. 2 - TDFN4 1.2 mm x 1.6 mm Package

PIN DESCRIPTION		
Pin Number	Name	Function
1	IN	This is the input pin of the switch
2	GND	Ground connection
3	EN	Enable input
4	OUT	This is the output pin of the switch

BLOCK DIAGRAM

Fig. 3 - Functional Block Diagram
DETAILED DESCRIPTION

SiP32448 and SiP32449 are advanced slew rate controlled high side load switches with an integrated N-channel power switch. When the device is enabled the gate of the power switch is turned on at a controlled rate to avoid excessive inrush current. Once fully on the gate to source voltage of the power switch is biased at a constant level. The design gives a flat on resistance throughout the operating voltages. A special reverse blocking circuitry prevents current flowing from output to input when the switch is off. The V_{IN} and EN pin can tolerate -2 V voltage without drawing excessive current.

APPLICATION INFORMATION
Input Capacitor

In general, under steady state conditions the SiP32448 and SiP32449 do not require an input capacitor. Nevertheless, an input bypass capacitor is recommended in order to reduce the input voltage drop caused by transient inrush currents. Commonly, a 2.2 μF ceramic capacitor is sufficient and should be placed in close proximity to V_{IN} and GND pins. A higher value input capacitor can help to further reduce the voltage drop. Ceramic capacitors are recommended for their low ESR characteristic.

Output Capacitor

While these devices work without an output capacitor, a 1 μF or higher value capacitor across V_{OUT} and GND is recommended in order to handle potential load transient conditions. In the event that the switch is turning off while running high current, circuit stray inductances might force the output to some negative voltage in order to mitigate this phenomenon a proper output capacitor is required.

Enable

The device is logic high active. Enable pin voltage can exceed V_{IN} as long as it is within the absolute maximum rating range. The EN pin is compatible with both TTL and CMOS logic voltage levels. The part features a constant

control logic threshold over the operation voltage range.

When enable pin is left open, a built-in voltage divider sets the internal logic. The switch will turn on when the V_{IN} exceeds the UVLO trip point.

Reverse Voltage Protection

The SiP32448 and SiP32449 contain a reverse blocking circuitry to protect the current from going to the input from the output when the switch is off. Reverse blocking works for input voltage as low as 0 V.

In case the EN pin is left open, the reverse blocking circuitry will prevent current flow from output pin to input pin if the output voltage is higher by at least 1 V than the input voltage.

THERMAL CONSIDERATIONS

The maximum allowed DC Current depends on the thermal condition in which the device operates. In order to calculate max allowed DC current, first the max power dissipation should be considered.

The SiP32448 and SiP32449 are packaged in a TDFN4 1.2 mm x 1.6 mm package which has a thermal resistance of $\theta_{J-A}^a = 170 \text{ }^\circ\text{C/W}$.

Note

- Device mounted with all leads and power pad soldered or welded to PC board, see PCB layout. For any other layout configuration the actual junction to ambient thermal impedance should be considered

The following formula shows the maximum allowed power dissipation as a function of the ambient temperature T_A when the maximum junction temperature is limited to $T_{J(max)} = 125 \text{ }^\circ\text{C}$:

$$P_{max} = \frac{T_{J(max)} - T_A}{\theta_{J-A}} = \frac{125 - T_A}{170}$$

For example at ambient temperature of 70 $^\circ\text{C}$, the maximum power dissipation will be limited to about 324 mW.

In order to calculate the maximum allowed DC current the switch $R_{DS(on)}$ temperature dependency should be considered.

As an example let us calculate maximum load current at $T_A = 70\text{ }^\circ\text{C}$ and input voltage of 1.8 V. At this input voltage the $R_{DS(on)}$ at $25\text{ }^\circ\text{C}$ 43 m Ω (see specification table). The $R_{DS(on)}$ at $125\text{ }^\circ\text{C}$ can be extrapolated from this data using the following formula:

$$R_{DS(on)_{125\text{ }^\circ\text{C}}} = R_{DS(on)_{25\text{ }^\circ\text{C}}} \times (1 + T_C \times (T_{J_{max}} - 25)/100)$$

Where T_C is the $R_{DS(on)}$ temperature coefficient expressed in percent change per degree C.

For SiP32448 the approximated value is 0.31 %/ $^\circ\text{C}$. $T_{J_{max}}$ is the maximum allowed junction temperature ($125\text{ }^\circ\text{C}$).

Therefore,

$$R_{DS(on)} \text{ (at } 125\text{ }^\circ\text{C)} = 43\text{ m}\Omega \times (1 + 0.31 \times (125 - 25)/100) \approx 57\text{ m}\Omega$$

The maximum current limit is then determined by

$$I_{LOAD \text{ (max.)}} < \sqrt{\frac{P \text{ (max.)}}{R_{DS(on)}}}$$

Which in this case is 2.38 A.

Due to device limitation the max switch DC current should exceed 3 A in any condition.

To obtain the highest power dissipation the power pad of the device should be connected to a heat sink on the printed circuit board. Figure 4 shows a typical PCB layout. All copper traces and vias for the V_{IN} and V_{OUT} pins should be sized adequately to carry the maximum continuous current.

Negative Input Voltage

The SiP32448 and SiP32449 can withstand maximum negative 2 V at its input due to any spike from abnormal or fault condition of the system.

Recommended Board Layout

For improved performance, all traces should be as short as possible to minimize stray inductances and parasitic effects. The input and output capacitors should be kept as close as possible to the input and output pins respectively. Connecting the central exposed pad to GND, using wide traces for input, output, and GND help reducing the case to ambient thermal impedance. See fig. 4.

BOARD LAYOUT

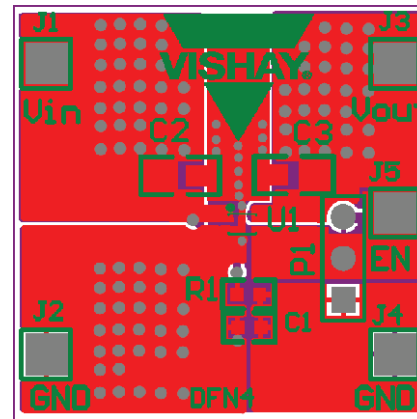


Fig. 4 - Recommended Board Layout

TYPICAL APPLICATION SCHEMATIC

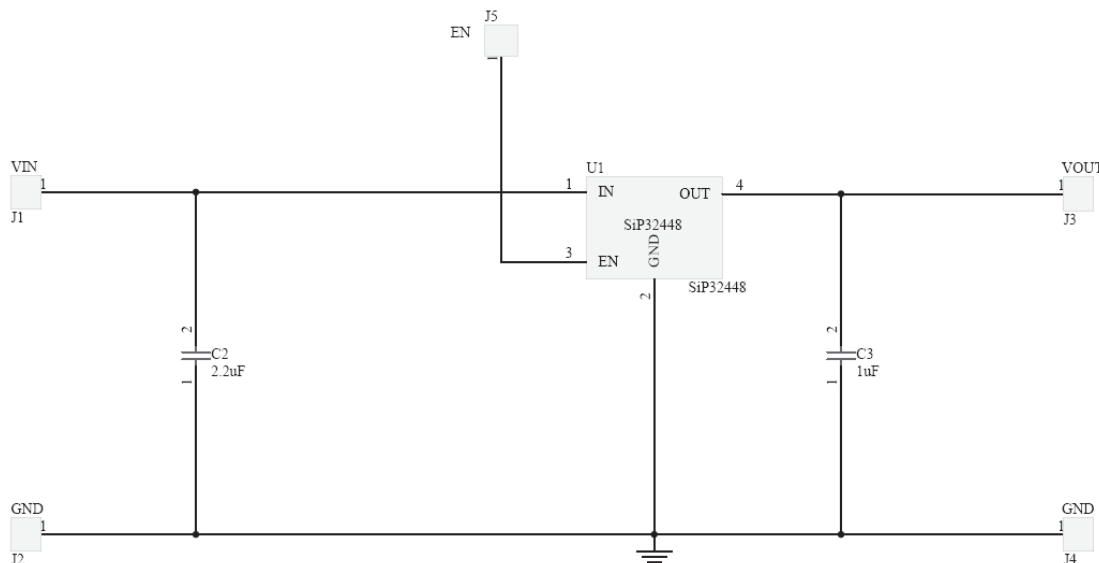
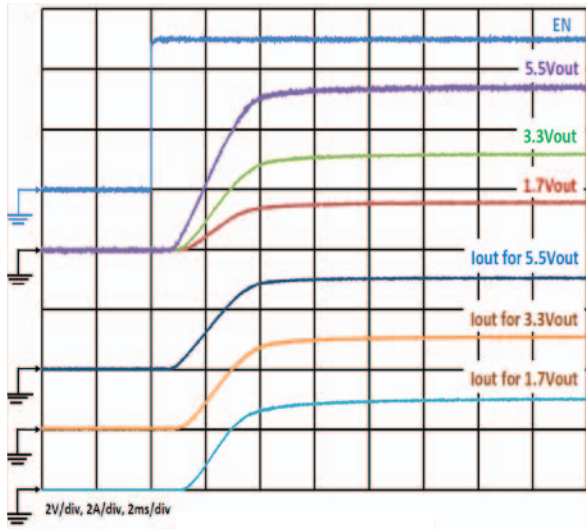


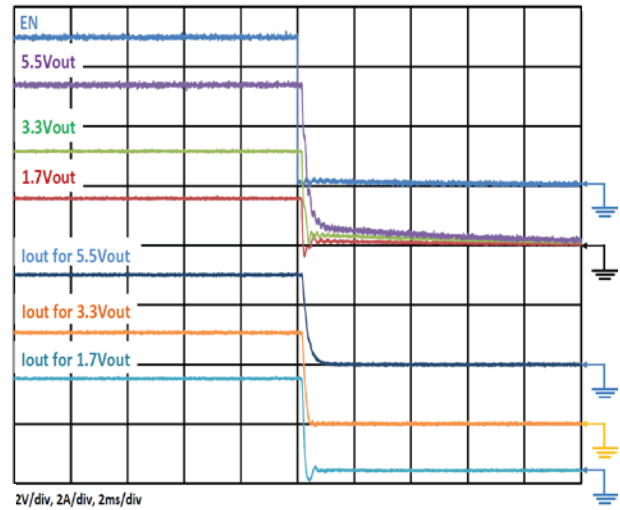
Fig. 5 - Application Schematic



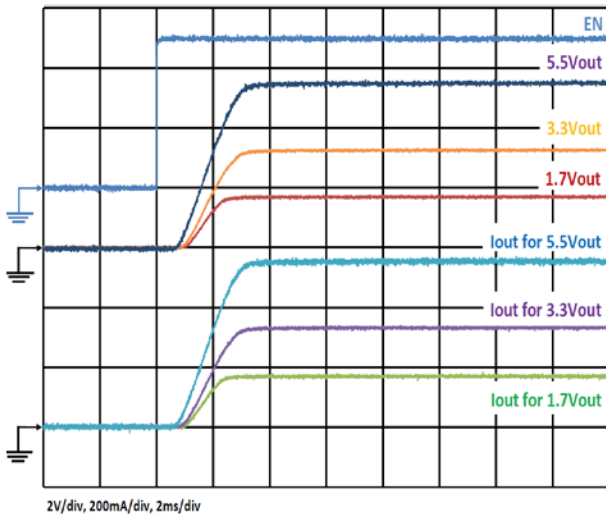
TYPICAL ENABLE POWER ON AND OFF WAVEFORMS



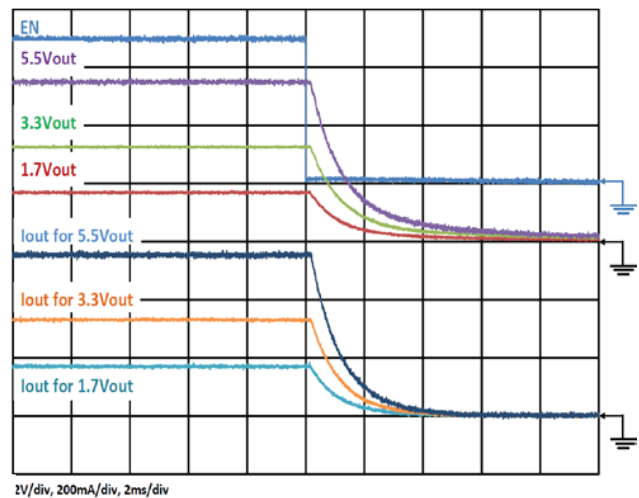
Typical Turn-On Delay, Rise Time, $C_{OUT} = 1 \mu F$, $C_{IN} = 2.2 \mu F$, $I_{OUT} = 3 A$



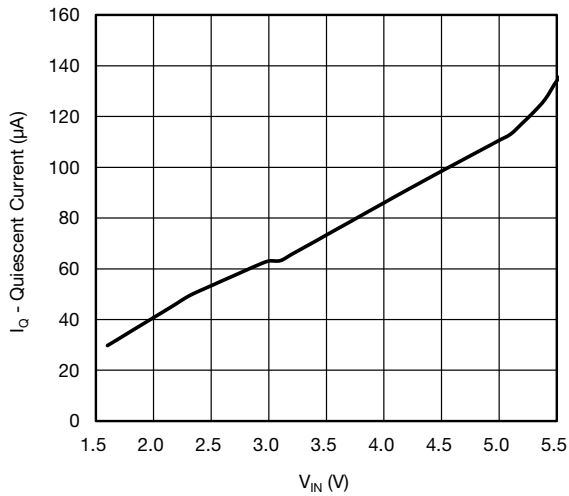
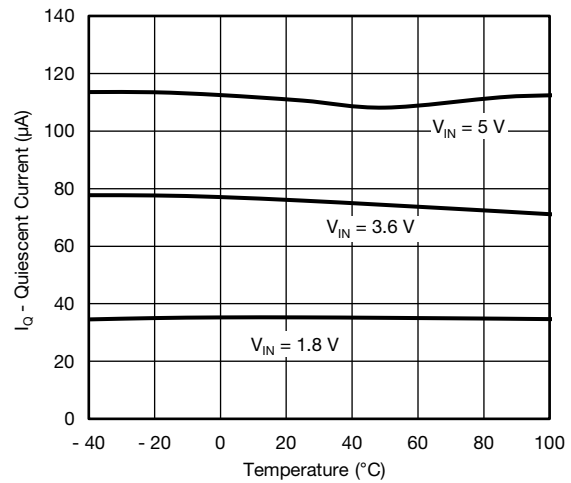
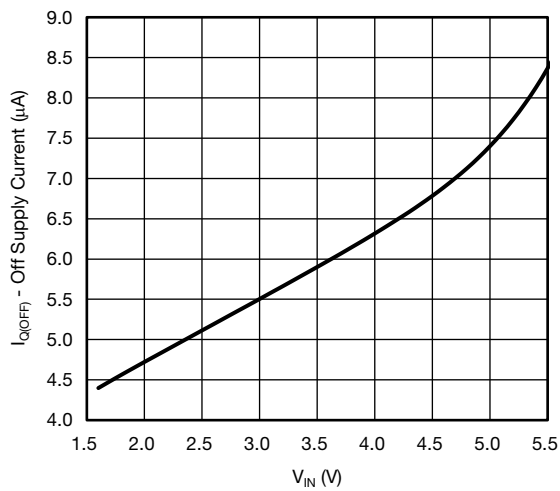
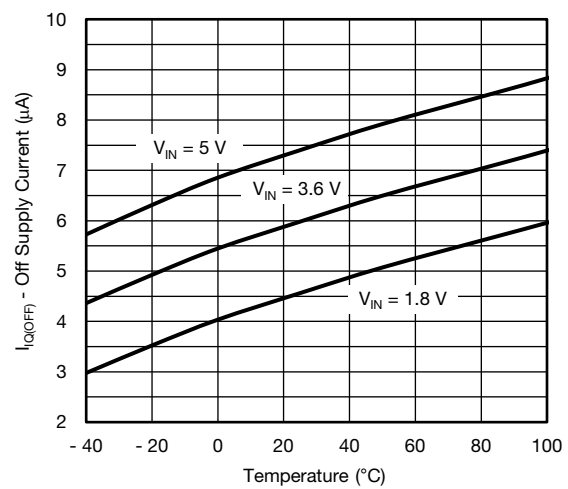
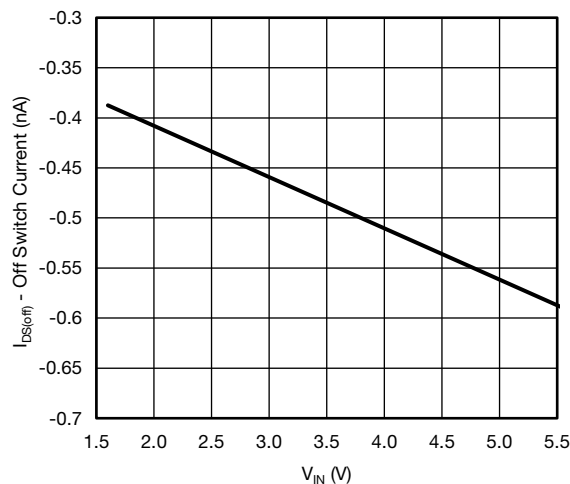
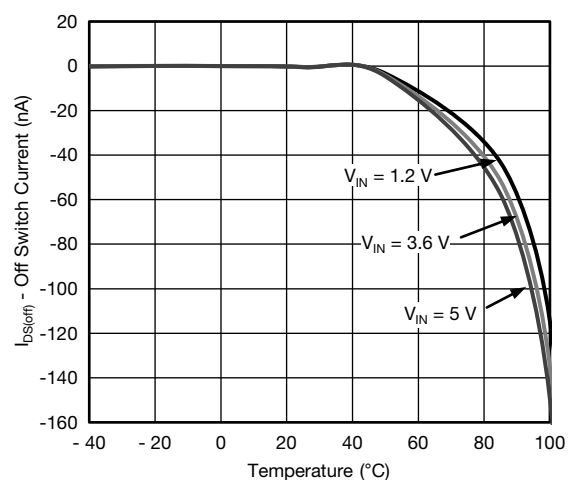
Typical Turn-Off Delay, Fall Time, $C_{OUT} = 1 \mu F$, $C_{IN} = 2.2 \mu F$, $I_{OUT} = 3 A$

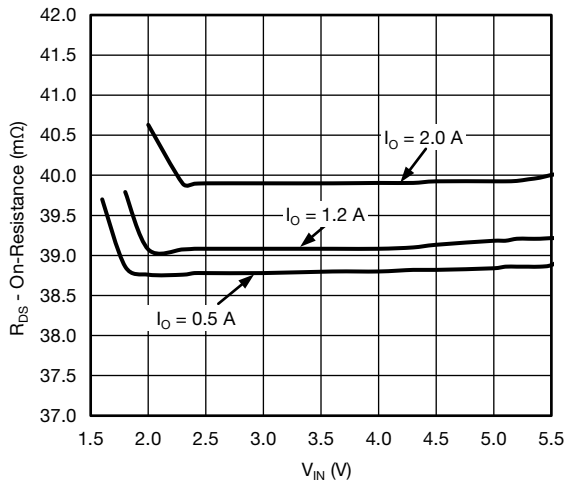
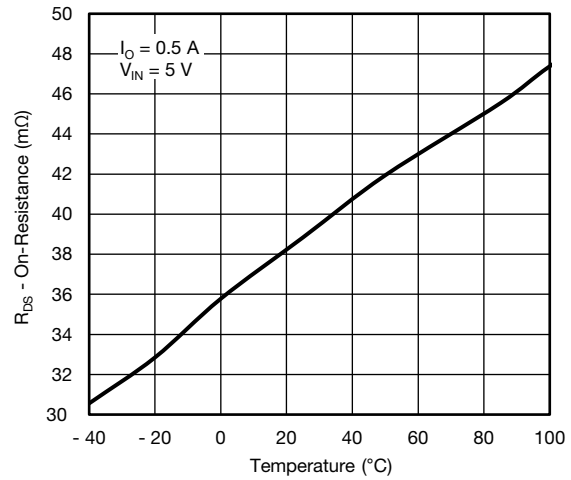
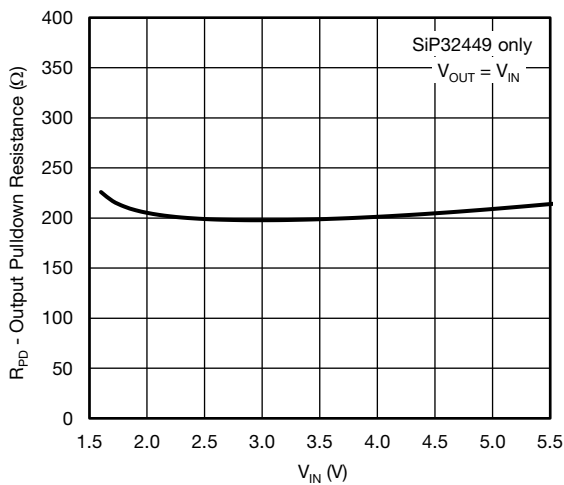
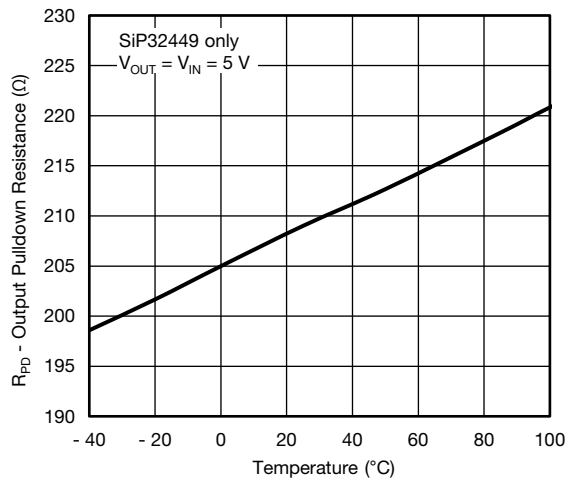
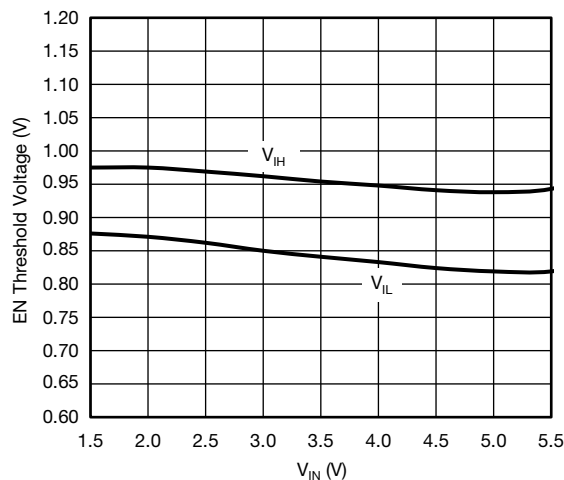
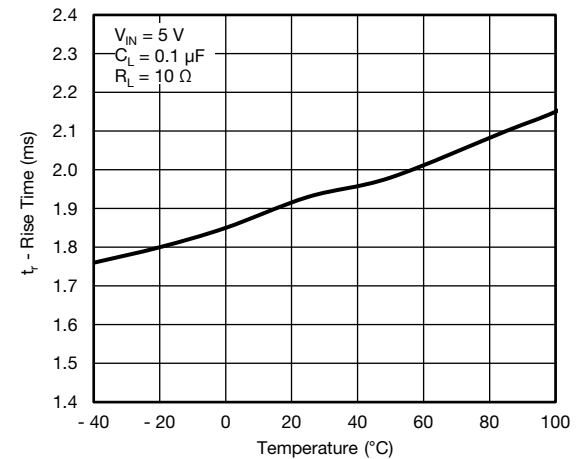


Typical Turn-On Delay, Rise Time, $C_{OUT} = 1 \mu F$, $C_{IN} = 2.2 \mu F$, $R_{OUT} = 10 \Omega$



Typical Turn-Off Delay, Fall Time, $C_{OUT} = 1 \mu F$, $C_{IN} = 2.2 \mu F$, $R_{OUT} = 10 \Omega$

TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

Fig. 6 - Quiescent Current vs. Input Voltage

Fig. 9 - Quiescent Current vs. Temperature

Fig. 7 - Off Supply Current vs. Input Voltage

Fig. 10 - Off Supply Current vs. Temperature

Fig. 8 - Off Switch Current vs. Input Voltage

Fig. 11 - Off Switch Current vs. Temperature

TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

Fig. 12 - On-Resistance vs. Input Voltage

Fig. 15 - On-Resistance vs. Temperature

Fig. 13 - Output Pulldown Resistance vs. V_{IN}

Fig. 16 - Output Pulldown Resistance vs. Temperature

Fig. 14 - Threshold Voltage vs. Input Voltage

Fig. 17 - Rise Time vs. Temperature



TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

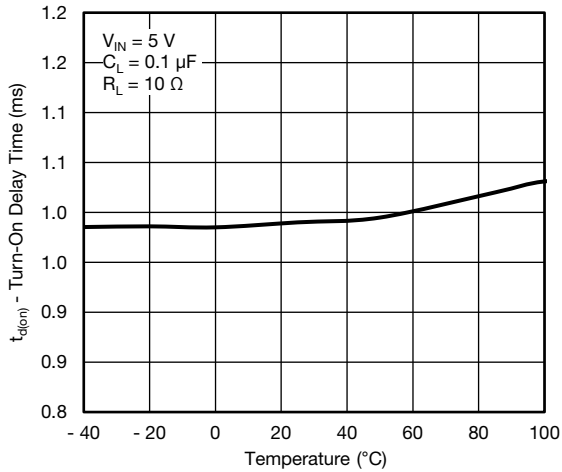


Fig. 18 - Turn-On Delay Time vs. Temperature

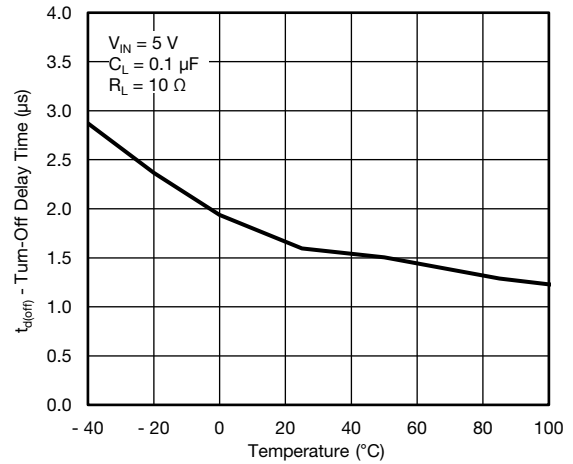


Fig. 20 - Turn-Off Delay Time vs. Temperature

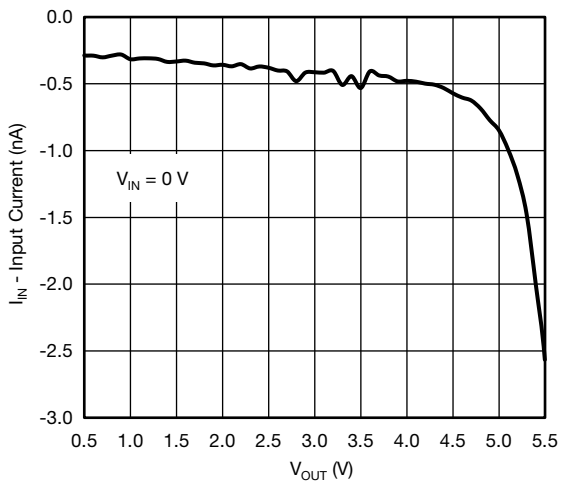


Fig. 19 - Reverse Blocking Current

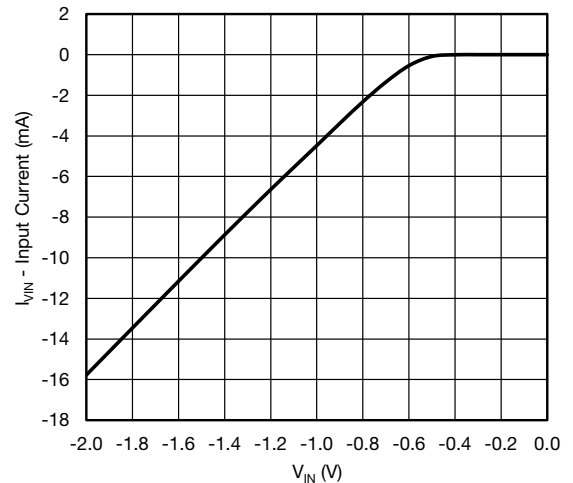
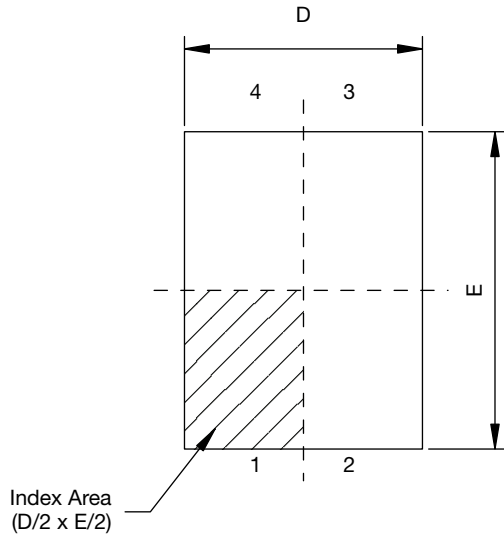


Fig. 21 - Negative Input Voltage Tolerance

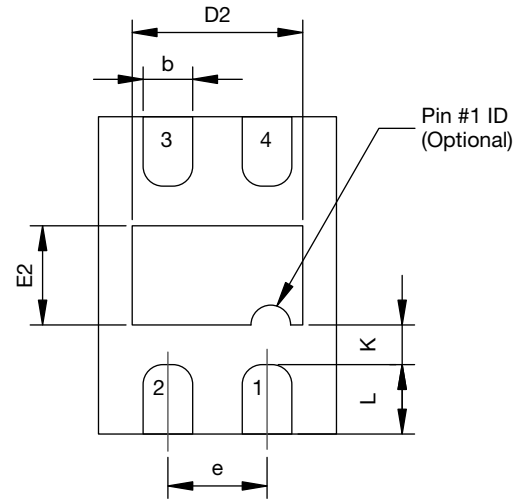
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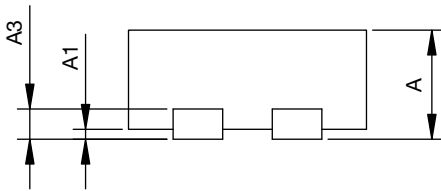
TDFN4 1.2 x 1.6 Case Outline



Top View



Bottom View



Side View

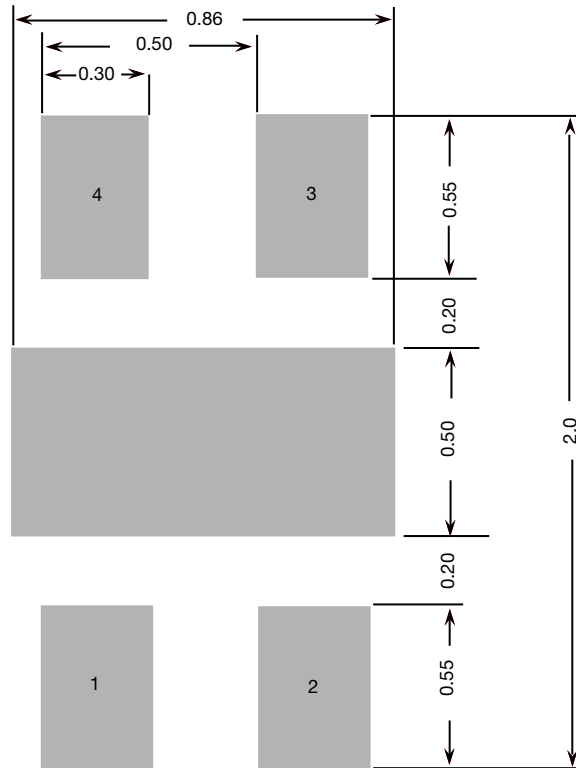
DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.45	0.55	0.60	0.017	0.022	0.024
A1	0.00	-	0.05	0.00	-	0.002
A3	0.15 REF. or 0.127 REF. ⁽¹⁾			0.006 or 0.005 ⁽¹⁾		
b	0.20	0.25	0.30	0.008	0.010	0.012
D	1.15	1.20	1.25	0.045	0.047	0.049
D2	0.81	0.86	0.91	0.032	0.034	0.036
e	0.50 BSC			0.020		
E	1.55	1.60	1.65	0.061	0.063	0.065
E2	0.45	0.50	0.55	0.018	0.020	0.022
K	0.25 typ.			0.010 typ.		
L	0.25	0.30	0.35	0.010	0.012	0.014

ECN: T16-0143-Rev. C, 18-Apr-16
DWG: 5995

Note

⁽¹⁾ The dimension depends on the leadframe that assembly house used.

RECOMMENDED MINIMUM PADS FOR TDFN4 1.2 x 1.6



Recommended Minimum Pads
Dimensions in mm



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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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